REF3212, REF3220 REF3225, REF3230 REF3233, REF3240

SBVS058B -JUNE 2005 - REVISED FEBRUARY 2006

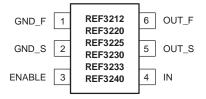
# 4ppm/°C, 100μA, SOT23-6 SERIES VOLTAGE REFERENCE

### **FEATURES**

- EXCELLENT SPECIFIED DRIFT PERFORMANCE:
  7ppm/°C (max) at 0°C to +125°C
  20ppm/°C (max) at -40°C to +125°C
- MICROSIZE PACKAGE: SOT23-6
- HIGH OUTPUT CURRENT: ±10mA
- HIGH ACCURACY: 0.01%
- LOW QUIESCENT CURRENT: 100μA
- LOW DROPOUT: 5mV

### **APPLICATIONS**

- PORTABLE EQUIPMENT
- DATA ACQUISITION SYSTEMS
- MEDICAL EQUIPMENT
- TEST EQUIPMENT



### DESCRIPTION

The REF32xx is a very low drift, micropower, low-dropout, precision voltage reference family available in the tiny SOT23-6 package.

The small size and low power consumption ( $120\mu A$  max) of the REF32xx make it ideal for portable and battery-powered applications. This reference is stable with any capacitive load.

The REF32xx can be operated from a supply as low as 5mV above the output voltage, under no load conditions. All models are specified for the wide temperature range of  $-40^{\circ}$ C to  $+125^{\circ}$ C.

#### **AVAILABLE OUTPUT VOLTAGES**

PRODUCT	VOLTAGE
REF3212	1.25V
REF3220	2.048V
REF3225	2.5V
REF3230	3.0V
REF3233	3.3V
REF3240	4.096V

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#### **ABSOLUTE MAXIMUM RATINGS(1)**

Input Voltage +7.5V
Output Short-Circuit
Operating Temperature
Storage Temperature
Junction Temperature+150°C
ESD Rating
Human Body Model 4kV
Charged Device Model 1kV
Machine Model

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe

proper handling and installation procedures can cause damage.

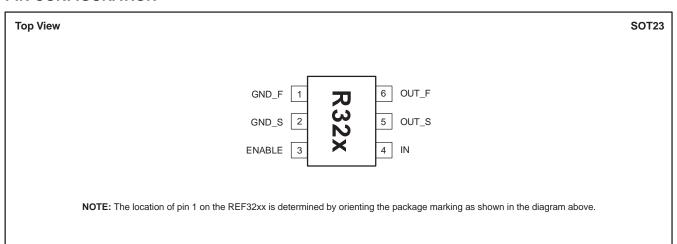
ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### PACKAGE/ORDERING INFORMATION(1)

PRODUCT	OUTPUT VOLTAGE	PACKAGE-LEAD	PACKAGE DESIGNATOR	PACKAGE MARKING
REF3212	1.25V	SOT23-6	DBV	R32A
REF3220	2.048V	SOT23-6	DBV	R32B
REF3225	2.5V	SOT23-6	DBV	R32C
REF3230	3.0V	SOT23-6	DBV	R32D
REF3233	3.30V	SOT23-6	DBV	R32E
REF3240	4.096V	SOT23-6	DBV	R32F

<sup>(1)</sup> For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

#### PIN CONFIGURATION





### **ELECTRICAL CHARACTERISTICS**

**Boldface** limits apply over the listed temperature range.

At  $T_A = +25$ °C,  $I_{LOAD} = 0$ mA, and  $V_{IN} = 5$ V, unless otherwise noted.

			REF32xx		
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
	REF3212 (1.25V)		l .	"	1
OUTPUT VOLTAGE, V <sub>OUT</sub>		1.2475	1.25	1.2525	V
Initial Accuracy		-0.2	0.01	0.2	%
NOISE					
Output Voltage Noise	f = 0.1Hz to 10Hz		17		$\mu V_{PP}$
Voltage Noise	f = 10Hz to 10kHz		24		$\mu V_{RMS}$
	REF3220 (2.048V)				
OUTPUT VOLTAGE, V <sub>OUT</sub>		2.044	2.048	2.052	V
Initial Accuracy		-0.2	0.01	0.2	%
NOISE					
Output Voltage Noise	f = 0.1Hz to 10Hz		27		$\mu V_{PP}$
Voltage Noise	f = 10Hz to 10kHz		39		$\mu V_{RMS}$
	REF3225 (2.5V)				
OUTPUT VOLTAGE, V <sub>OUT</sub>		2.495	2.50	2.505	V
Initial Accuracy		-0.2	0.01	0.2	%
NOISE					
Output Voltage Noise	f = 0.1Hz to 10Hz		33		$\mu V_{PP}$
Voltage Noise	f = 10Hz to 10kHz		48		$\mu V_{RMS}$
	REF3230 (3V)				
OUTPUT VOLTAGE, V <sub>OUT</sub>		2.994	3	3.006	V
Initial Accuracy		-0.2	0.01	0.2	%
NOISE					
Output Voltage Noise	f = 0.1Hz to 10Hz		39		$\mu V_{PP}$
Voltage Noise	f = 10Hz to 10kHz		57		$\mu V_{RMS}$
	REF3233 (3.3V)				
OUTPUT VOLTAGE, V <sub>OUT</sub>		3.293	3.3	3.307	V
Initial Accuracy		-0.2	0.01	0.2	%
NOISE					
Output Voltage Noise	f = 0.1Hz to 10Hz		43		$\mu V_{PP}$
Voltage Noise	f = 10Hz to 10kHz		63		$\mu V_{RMS}$
	REF3240 (4.096V)	•		•	•
OUTPUT VOLTAGE, V <sub>OUT</sub>		4.088	4.096	4.104	V
Initial Accuracy		-0.2	0.01	0.2	%
NOISE					
Output Voltage Noise	f = 0.1Hz to 10Hz		53		$\mu V_{PP}$
Voltage Noise	f = 10Hz to 10kHz		78		$\mu V_{RMS}$



### **ELECTRICAL CHARACTERISTICS (continued)**

Boldface limits apply over the listed temperature range.

At  $T_A$  = +25°C,  $I_{LOAD}$  = 0mA, and  $V_{IN}$  = 5V, unless otherwise noted.

				REF32xx		
PARAMETER		CONDITIONS	MIN	TYP	MAX	UNIT
RE	F3212 / RE	F3220 / REF3225 / REF3230 / R	EF3233 / RE	F3240		
OUTPUT VOLTAGE TEMP DRIFT	dV <sub>out</sub> /dT					
		$0^{\circ}C \le T_{A} \le +125^{\circ}C$		4	7	ppm/°C
		-40°C ≤ T <sub>A</sub> ≤ +125°C		10.5	20	ppm/°C
LONG-TERM STABILITY						
		0 to 1000h		55		ppm
LINE REGULATION		$V_{OUT} + 0.05(1) \le V_{IN} \le 5.5V$	-65	15	+65	ppm/V
LOAD REGULATION	dV <sub>OUT</sub> /dI <sub>LOAD</sub>					
Sourcing		$0mA < I_{LOAD} < 10mA, V_{IN} = V_{OUT} + 250mV(1)$	-40	3	40	μV/mA
Sinking		$-10\text{mA} < I_{LOAD} < 0\text{mA}, V_{IN} = V_{OUT} + 100\text{mV}(1)$	-60	20	60	μV/mA
THERMAL HYSTERESIS(2)	dT					
First cycle				100		ppm
Additional cycles				25		ppm
DROPOUT VOLTAGE(1)	V <sub>IN</sub> -V <sub>OUT</sub>	0°C ≤ T <sub>A</sub> ≤ +125°C		5	50	mV
OUTPUT CURRENT	I <sub>LOAD</sub>	V <sub>IN</sub> = V <sub>OUT</sub> + 250mV(1)	-10		10	mA
SHORT-CIRCUIT CURRENT	I <sub>SC</sub>					
Sourcing				50		mA
Sinking				40		mA
TURN-ON SETTLING TIME		to 0.1% at $V_{IN} = 5V$ with $C_L = 0$		60		μs
ENABLE/SHUTDOWN						
	$V_L$	Reference in Shutdown mode	0		0.7	V
	$V_{H}$	Reference is active	$0.75 \times V_{IN}$		$V_{IN}$	V
POWER SUPPLY		I <sub>L</sub> = 0				
Voltage	$V_{IN}$		V <sub>OUT</sub> + 0.05 <sup>(1)</sup>		5.5	V
Current	$I_Q$	ENABLE > 0.75 x V <sub>IN</sub>		100	120	μΑ
Over-temperature		0°C ≤ T <sub>A</sub> ≤ +125°C		115	135	μ <b>Α</b>
Shutdown	IS	ENABLE < 0.7V		0.1	1	μΑ
TEMPERATURE RANGE						
Specified			-40		+125	°C
Operating			-55		+135	°C
Storage			-65		+150	°C
Thermal resistance, SOT23-6	θЈА			200		°C/W

<sup>(1)</sup> The minimum supply voltage for the REF3212 is 1.8V.

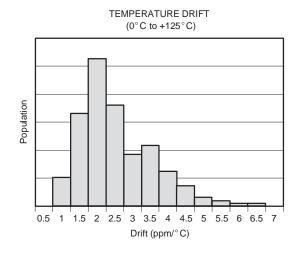
<sup>(2)</sup> Thermal hysteresis procedure is explained in more detail in the *Applications Information* section.

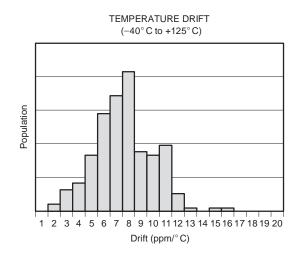
<sup>(3)</sup> Load regulation is using force and sense lines; see the *Load Regulation* section for more information.

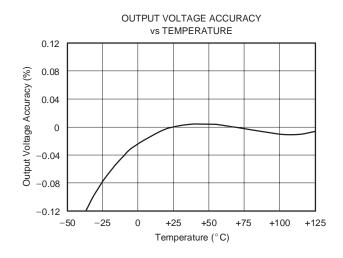


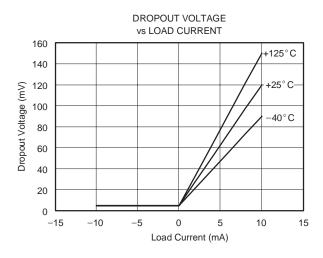
### TYPICAL CHARACTERISTICS

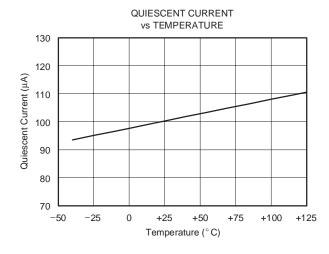
At T<sub>A</sub> = +25°C, I<sub>LOAD</sub> = 0mA, V<sub>IN</sub> = +5V power supply, REF3225 is used for typical characteristics, unless otherwise noted.

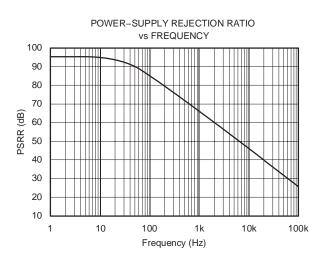








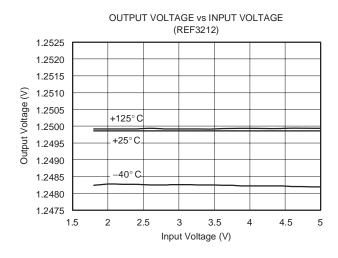


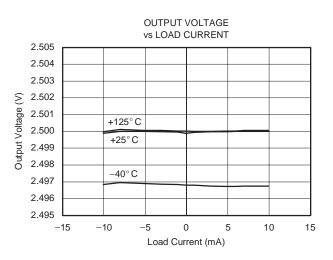


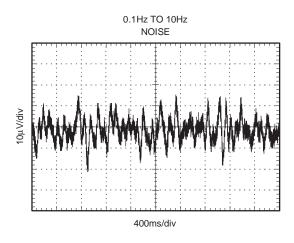


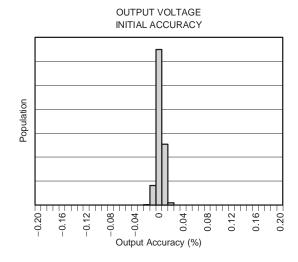
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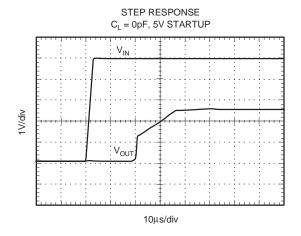
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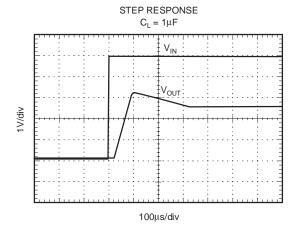








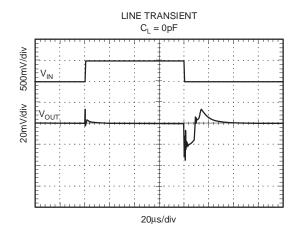


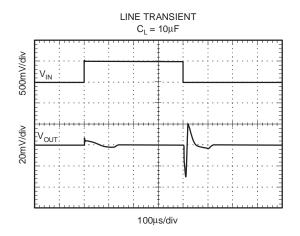


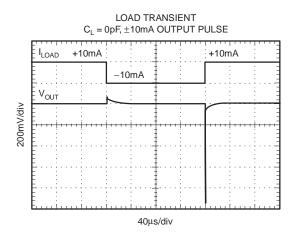


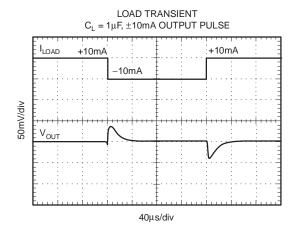
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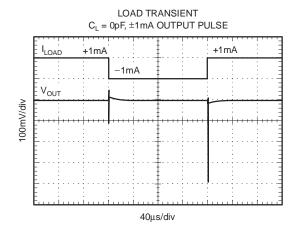
At  $T_A = +25^{\circ}C$ ,  $I_{LOAD} = 0$ mA,  $V_{IN} = +5V$  power supply, REF3225 is used for typical characteristics, unless otherwise noted.

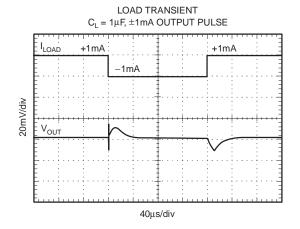








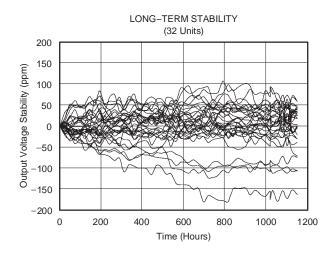






### **TYPICAL CHARACTERISTICS (continued)**

At  $T_A = +25^{\circ}C$ ,  $I_{LOAD} = 0$ mA,  $V_{IN} = +5V$  power supply, REF3225 is used for typical characteristics, unless otherwise noted.



### THEORY OF OPERATION

The REF32xx is a family of CMOS, precision bandgap voltage references. Figure 1 shows the basic bandgap topology. Transistors  $Q_1$  and  $Q_2$  are biased so that the current density of  $Q_1$  is greater than that of  $Q_2$ . The difference of the two base-emitter voltages (Vbe<sub>1</sub> – Vbe<sub>2</sub>) has a positive temperature coefficient and is forced across resistor  $R_1$ . This voltage is amplified and added to the base-emitter voltage of  $Q_2$ , which has a negative temperature coefficient. The resulting output voltage is virtually independent of temperature.

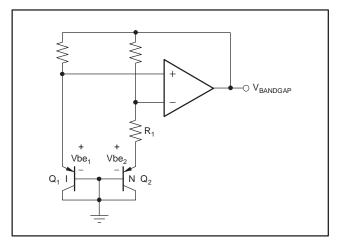


Figure 1. Simplified Schematic of Bandgap Reference

### APPLICATION INFORMATION

The REF32xx does not require a load capacitor and is stable with any capacitive load. Figure 2 shows typical connections required for operation of the REF32xx. A supply bypass capacitor of  $0.47\mu F$  is recommended.

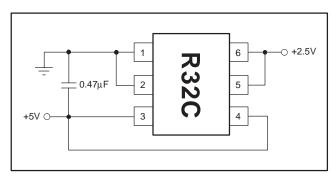


Figure 2. Typical Operating Connections for the

#### SUPPLY VOLTAGE

The REF32xx family of references features an extremely low dropout voltage. With the exception of the REF3212, which has a minimum supply requirement of 1.8V, these references can be operated with a supply of only 5mV above the output voltage in an unloaded condition. For loaded conditions, a typical dropout voltage versus load is shown in the Typical Characteristic curves.



The REF32xx also features a low quiescent current of  $100\mu A$ , with a maximum quiescent current over temperature of just  $135\mu A$ . The quiescent current typically changes less than  $2\mu A$  over the entire supply range, as shown in Figure 3.

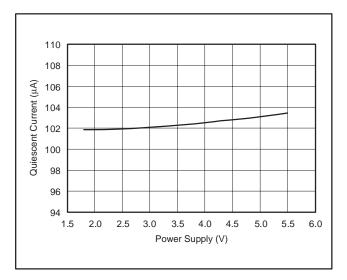


Figure 3. Supply Current vs Supply Voltage

Supply voltages below the specified levels can cause the REF32xx to momentarily draw currents greater than the typical quiescent current. This momentary current draw can be prevented by using a power supply with a fast rising edge and low output impedance.

#### **SHUTDOWN**

The REF32xx can be placed in a low-power mode by pulling the ENABLE/SHUTDOWN pin low. When in Shutdown mode, the output of the REF32xx becomes a resistive load to ground. The value of the load depends on the model, and ranges from approximately  $100k\Omega$  to  $400k\Omega$ .

#### THERMAL HYSTERESIS

Thermal hysteresis for the REF32xx is defined as the change in output voltage after operating the device at +25°C, cycling the device through the specified temperature range, and returning to +25°C. It can be expressed as:

$$V_{HYST} = \left(\frac{|V_{PRE} - V_{POST}|}{V_{NOM}}\right) \times 10^{6} (ppm)$$
 (1)

Where:

V<sub>HYST</sub> = thermal hysteresis (in units of ppm).

 $V_{NOM}$  = the specified output voltage.

V<sub>PRE</sub> = output voltage measured at +25°C pretemperature cycling.

V<sub>POST</sub> = output voltage measured after the device has been cycled through the specified temperature range of -40°C to +125°C and returned to +25°C.

#### **TEMPERATURE DRIFT**

The REF32xx is designed to exhibit minimal drift error, which is defined as the change in output voltage over varying temperature. The drift is calculated using the box method, as described by the following equation:

Drift = 
$$\left(\frac{V_{OUTMAX} - V_{OUTMIN}}{V_{OUT} \times Temp Range}\right) \times 10^{6} (ppm)$$
 (2)

The REF32xx features a typical drift coefficient of 4ppm/°C from 0°C to +125°C—the primary temperature range for many applications. For the extended industrial temperature range of -40°C to +125°C, the REF32xx family drift increases to a typical value of 10.5ppm/°C.

#### **NOISE PERFORMANCE**

Typical 0.1Hz to 10Hz voltage noise can be seen in the Typical Characteristic curve, 0.1 to 10Hz Voltage Noise. The noise voltage of the REF32xx increases with output voltage and operating temperature. Additional filtering can be used to improve output noise levels, although care should be taken to ensure the output impedance does not degrade AC performance.



#### LONG-TERM STABILITY

Long-term stability refers to the change of the output voltage of a reference over a period of months or years. This effect lessens as time progresses, as is shown by the long-term stability Typical Characteristic curves. The typical drift value for the REF32xx is 55ppm from 0 to 1000 hours. This parameter is characterized by measuring 30 units at regular intervals for a period of 1000 hours.

#### LOAD REGULATION

Load regulation is defined as the change in output voltage as a result of changes in load current. The load regulation of the REF32xx is measured using force and sense contacts, as shown in Figure 4. The force and sense lines can be used to effectively eliminate the impact of contact and trace resistance, resulting in accurate voltage at the load. By connecting the force and sense lines at the load, the REF32xx compensates for the contact and trace resistances because it measures and adjusts the voltage actually delivered at the load.

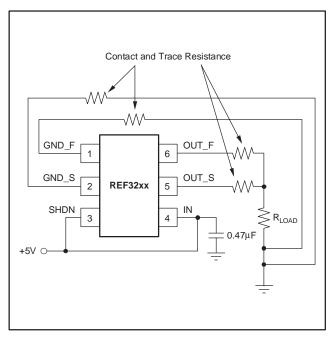


Figure 4. Accurate Load Regulation of REF32xx

### APPLICATION CIRCUITS

#### **NEGATIVE REFERENCE VOLTAGE**

For applications requiring a negative and positive reference voltage, the REF32xx and OPA735 can be used to provide a dual-supply reference from a  $\pm 5V$  supply. Figure 5 shows the REF3225 used to provide a  $\pm 2.5V$  supply reference voltage. The low drift performance of the REF32xx complements the low offset voltage and zero drift of the OPA735 to provide an accurate solution for split-supply applications. Care must be taken to match the temperature coefficients of  $R_1$  and  $R_2$ .

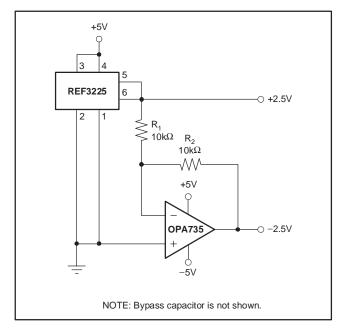


Figure 5. REF3225 Combined with OPA735 to Create Positive and Negative Reference Voltages

#### DATA ACQUISITION

Data acquisition systems often require stable voltage references to maintain accuracy. The REF32xx family features stability and a wide range of voltages suitable for most microcontrollers and data converters. Figure 6, Figure 7, and Figure 8 show basic data acquisition systems.



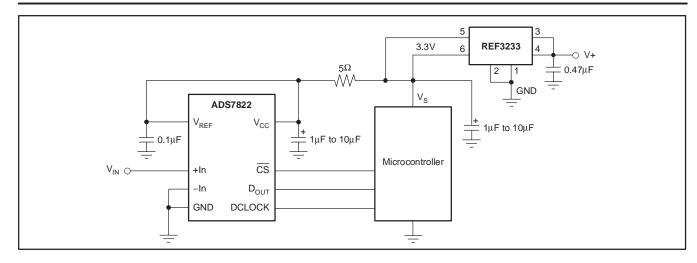


Figure 6. Basic Data Acquisition System 1

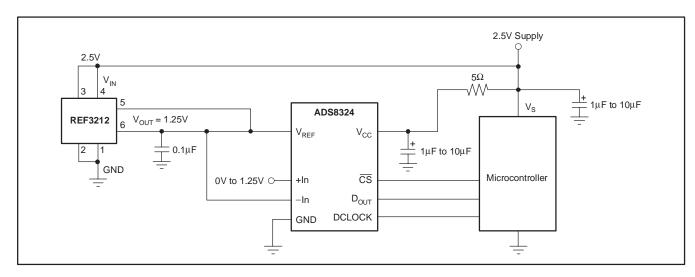


Figure 7. Basic Data Acquisition System 2

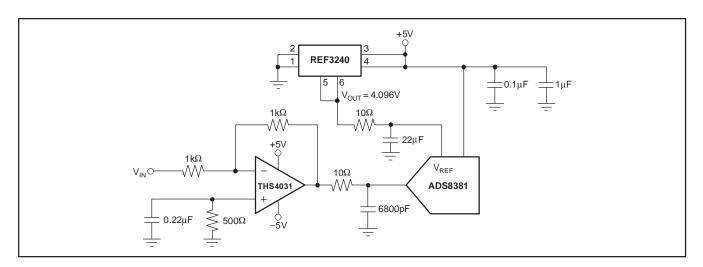


Figure 8. REF3240 Provides an Accurate Reference for Driving the ADS8381

## **PACKAGE OPTION ADDENDUM**





### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
REF3212AIDBVR	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3212AIDBVRG4	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3212AIDBVT	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3212AIDBVTG4	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3220AIDBVR	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3220AIDBVRG4	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3220AIDBVT	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3220AIDBVTG4	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3225AIDBVR	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3225AIDBVRG4	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3225AIDBVT	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3225AIDBVTG4	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3230AIDBVR	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3230AIDBVRG4	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3230AIDBVT	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3230AIDBVTG4	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3233AIDBVR	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3233AIDBVRG4	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3233AIDBVT	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3233AIDBVTG4	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3240AIDBVR	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3240AIDBVRG4	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3240AIDBVT	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3240AIDBVTG4	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR

<sup>&</sup>lt;sup>(1)</sup> The marketing status values are defined as follows:



#### PACKAGE OPTION ADDENDUM

18-Sep-2008

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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#### OTHER QUALIFIED VERSIONS OF REF3212, REF3220, REF3225, REF3230, REF3233, REF3240:

• Enhanced Product: REF3212-EP, REF3220-EP, REF3225-EP, REF3230-EP, REF3233-EP, REF3240-EP

NOTE: Qualified Version Definitions:

• Enhanced Product - Supports Defense, Aerospace and Medical Applications

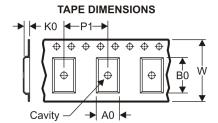
### PACKAGE MATERIALS INFORMATION



com 20-Sep-2008

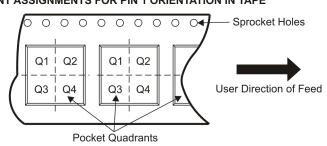
### TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
REF3212AIDBVR	SOT-23	DBV	6	3000	180.0	8.4	3.2	3.1	1.39	4.0	8.0	Q3
REF3212AIDBVT	SOT-23	DBV	6	250	180.0	8.4	3.2	3.1	1.39	4.0	8.0	Q3
REF3220AIDBVR	SOT-23	DBV	6	3000	180.0	8.4	3.2	3.1	1.39	4.0	8.0	Q3
REF3220AIDBVT	SOT-23	DBV	6	250	180.0	8.4	3.2	3.1	1.39	4.0	8.0	Q3
REF3225AIDBVR	SOT-23	DBV	6	3000	180.0	8.4	3.2	3.1	1.39	4.0	8.0	Q3
REF3225AIDBVT	SOT-23	DBV	6	250	180.0	8.4	3.2	3.1	1.39	4.0	8.0	Q3
REF3230AIDBVR	SOT-23	DBV	6	3000	180.0	8.4	3.2	3.1	1.39	4.0	8.0	Q3
REF3230AIDBVT	SOT-23	DBV	6	250	180.0	8.4	3.2	3.1	1.39	4.0	8.0	Q3
REF3233AIDBVR	SOT-23	DBV	6	3000	180.0	8.4	3.2	3.1	1.39	4.0	8.0	Q3
REF3233AIDBVT	SOT-23	DBV	6	250	180.0	8.4	3.2	3.1	1.39	4.0	8.0	Q3
REF3240AIDBVR	SOT-23	DBV	6	3000	180.0	8.4	3.2	3.1	1.39	4.0	8.0	Q3
REF3240AIDBVT	SOT-23	DBV	6	250	180.0	8.4	3.2	3.1	1.39	4.0	8.0	Q3

## **PACKAGE MATERIALS INFORMATION**

20-Sep-2008

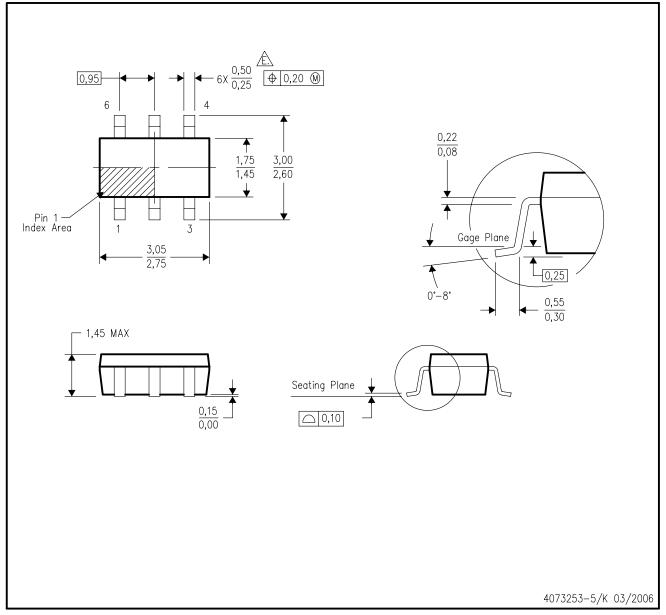


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
REF3212AIDBVR	SOT-23	DBV	6	3000	190.5	212.7	31.8
REF3212AIDBVT	SOT-23	DBV	6	250	190.5	212.7	31.8
REF3220AIDBVR	SOT-23	DBV	6	3000	190.5	212.7	31.8
REF3220AIDBVT	SOT-23	DBV	6	250	190.5	212.7	31.8
REF3225AIDBVR	SOT-23	DBV	6	3000	190.5	212.7	31.8
REF3225AIDBVT	SOT-23	DBV	6	250	190.5	212.7	31.8
REF3230AIDBVR	SOT-23	DBV	6	3000	190.5	212.7	31.8
REF3230AIDBVT	SOT-23	DBV	6	250	190.5	212.7	31.8
REF3233AIDBVR	SOT-23	DBV	6	3000	190.5	212.7	31.8
REF3233AIDBVT	SOT-23	DBV	6	250	190.5	212.7	31.8
REF3240AIDBVR	SOT-23	DBV	6	3000	190.5	212.7	31.8
REF3240AIDBVT	SOT-23	DBV	6	250	190.5	212.7	31.8

## DBV (R-PDSO-G6)

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
- Falls within JEDEC MO-178 Variation AB, except minimum lead width.

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